

Title (en)

DEVICE FOR SELECTIVELY PROCESSING INDIVIDUAL COMPONENTS OF A FLAT ELECTRONIC SUB-ASSEMBLY

Title (de)

VORRICHTUNG ZUM SELEKTIVEN BEARBEITEN EINZELNER BAUTEILE EINER ELEKTRONISCHEN FLACHBAUGRUPPE

Title (fr)

DISPOSITIF PERMETTANT DE TRAVAILLER DE FA ON SELECTIVE SUR DES COMPOSANTS INDIVIDUELS D'UN ENSEMBLE PLAT ELECTRONIQUE

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Application

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Abstract (en)

[origin: DE19716392A1] The invention relates to a device for selectively processing on individual components of a flat electronic sub-assembly in predetermined ambient conditions. This device comprises a receptacle for lodging the sub-assembly module, the cover surface (18) of which has an opening (44) for inserting a working tool. The opening (44) is formed excentrically in a disc (52) which is rotationally mounted in the covering surface (18).

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